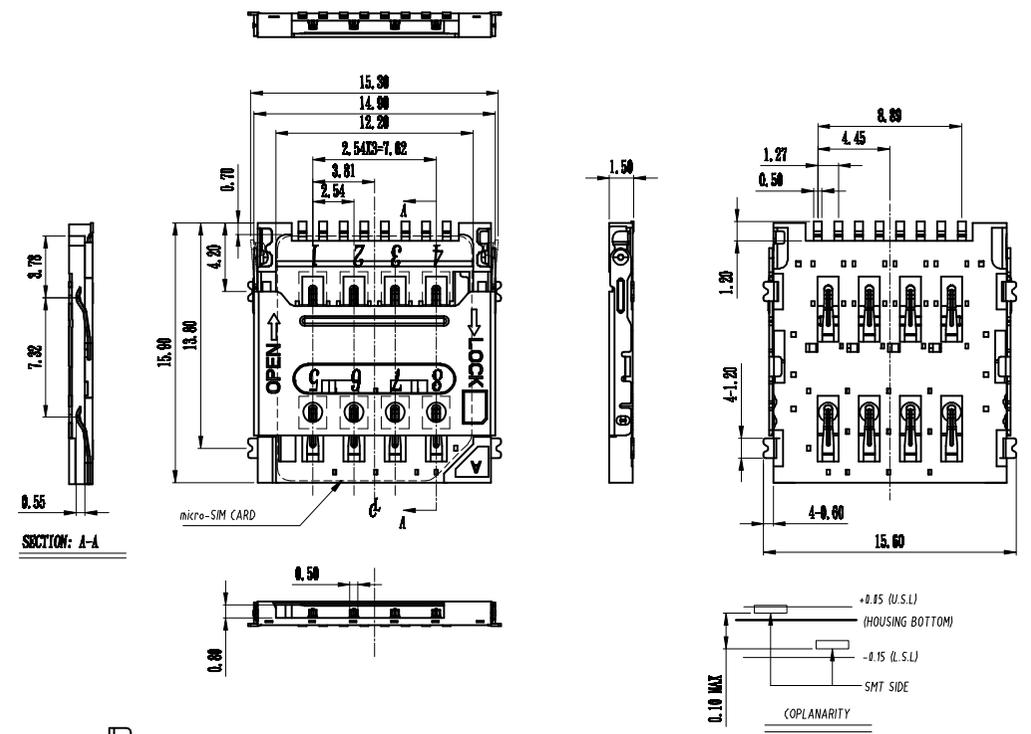
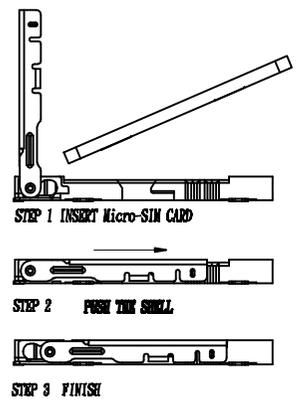
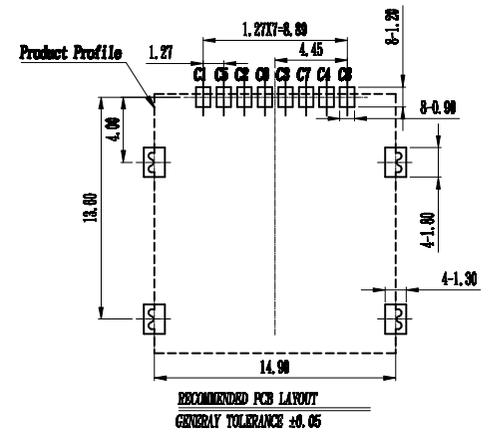


RoHS HSF



- NOTES:**
- ELECTRICAL CHARACTERISTICS**
 - CONTACT RESISTANCE: 80 Milliohms Max.
 - INSULATION RESISTANCE: 1,000 Megohms Min.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE.
 - MECHANICAL CHARACTERISTICS**
 - OPERATION TEMPERATURE RANGE: -25°C~+70°C
 - DURABILITY: 5000 CYCLES
 - MATERIAL:**
 - HOUSING: THERMOPLASTIC, UL 94-V0
 - TERMINAL: PHOSPHOR BRONZE, T-0.15
 - SHELL: STAINLESS STEEL, T-0.15
 - FINISHES:**
 - TERMINAL: Ni PLATED UNDER, Au PLATED ON CONTACT AREA, G/F PLATED ON SOLDER TAIL.



SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	TPP
C7	I/O
C8	RESERVED

						General	Angle	设计			
						X±0.50	X'±2'	DESIGN			
						.X±0.30	.X'±1'	校阅			
						.XX±0.20	.XX'±0.5'	CHECK			
	A		NEW RELEASE					承认			
工程变更通知单号 ECN(DCN) NO.	版次 REV	日期 DATE	说明 DESCRIPTION	改变 CHANGE	承认 APPRO.	GENERAL TOLERANCE UNLESS OTHERWISE SPECIFIED		承认 APPRO.			

JB Bossie (博锡)

PRODUCT SPEC. MICRO SIM

PART NO. 翻盖式 MicroSIM卡卡座

TITLE: BX-SIM-1.5HJ

FILE NAME:

SCALE 1:1 UNIT:mm A4 SHEET: 1 of 1